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(12) **United States Design Patent**
Di Stefano

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(54) **RESILIENT MICROELECTRONIC CONNECTOR**

(75) Inventor: **Thomas H. Di Stefano**, Monte Sereno, CA (US)

(73) Assignee: **Centipede Systems, Inc.**, San Jose, CA (US)

(**) Term: **14 Years**

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(51) **LOC (9) Cl.** **13-03**

(52) **U.S. Cl.** **D13/133; D13/154**

(58) **Field of Classification Search** D13/133–136, D13/154, 184, 199; 439/168, 220, 226, 232, 439/280, 336, 419, 602; D26/24, 113; 313/318.01–318.05, 313/318.12; 362/260, 581

See application file for complete search history.

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Primary Examiner—Daniel D Bui

Assistant Examiner—Thomas J Johannes

(74) *Attorney, Agent, or Firm*—Townsend and Townsend and Crew LLP; Kenneth R. Allen

(57) **CLAIM**

The ornamental design for resilient microelectronic connector, as shown and described.

DESCRIPTION

The resilient microelectronic connector is used for making electrical and mechanical connection between a mating ball terminal as shown in FIG. 7 with broken line proximal to the top of the connector, and a second terminal, as shown in FIG. 7 with broken line proximal to the bottom of the resilient microelectronic connector. Two resilient microelectronic connectors may be joined at the tubular base of each connector thereby forming a double ended microelectronic connector as shown in FIG. 7.

FIG. 1 is a perspective view of a resilient microelectronic connector showing my new design;

FIG. 2 is a front elevational view thereof, the rear elevational view being identical to the front elevational view;

FIG. 3 is a left side elevational view thereof;

FIG. 4 is a right side elevational view thereof;

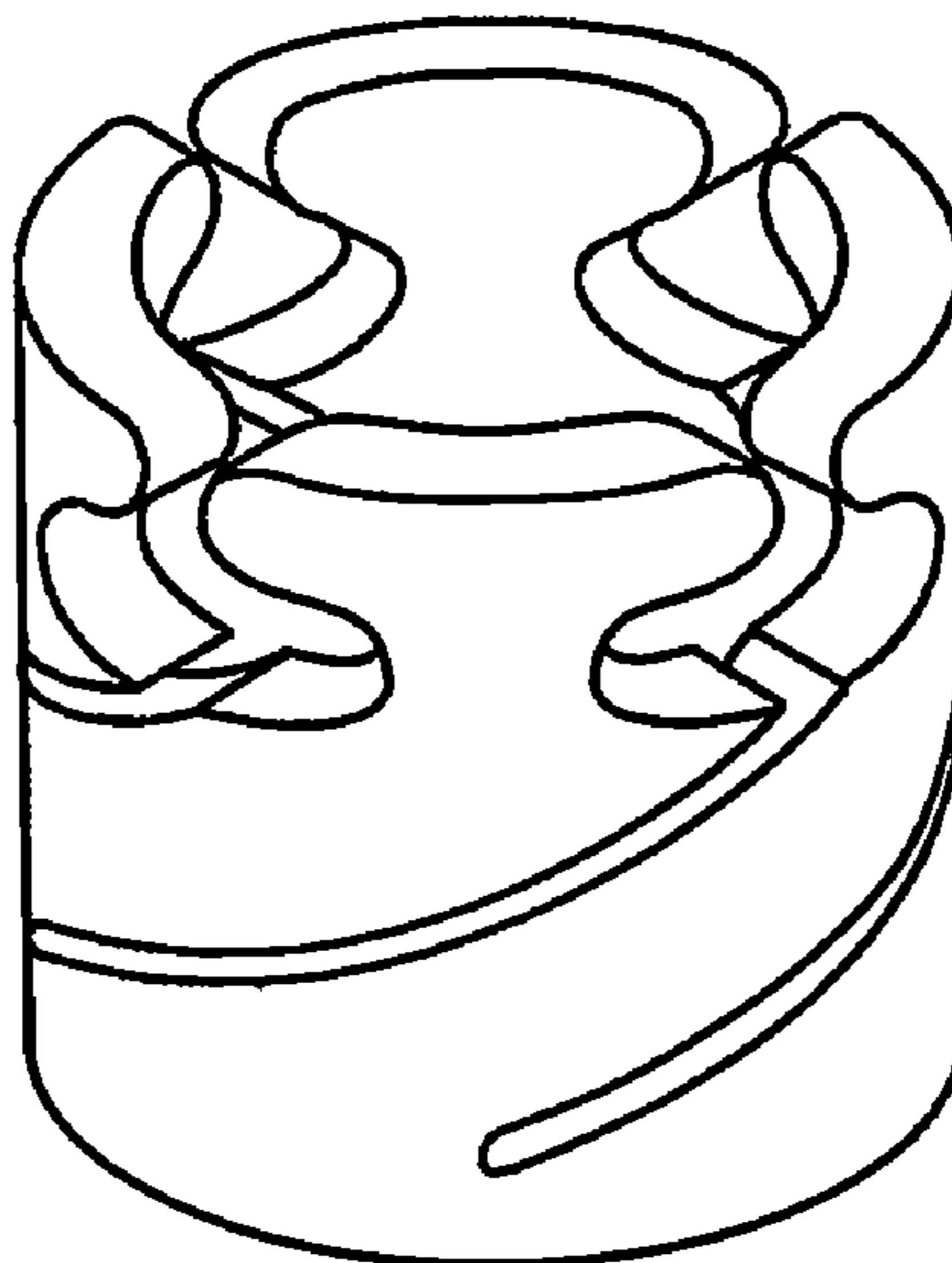
FIG. 5 is a bottom view thereof;

FIG. 6 is a top plan view thereof; and,

FIG. 7 is a rear elevational view thereof, showing a typical usage configuration.

The broken line portions of FIG. 7 are included to show two unclaimed mating ball terminals and an unclaimed microelectronic connector only and form no part of the claimed design.

1 Claim, 1 Drawing Sheet



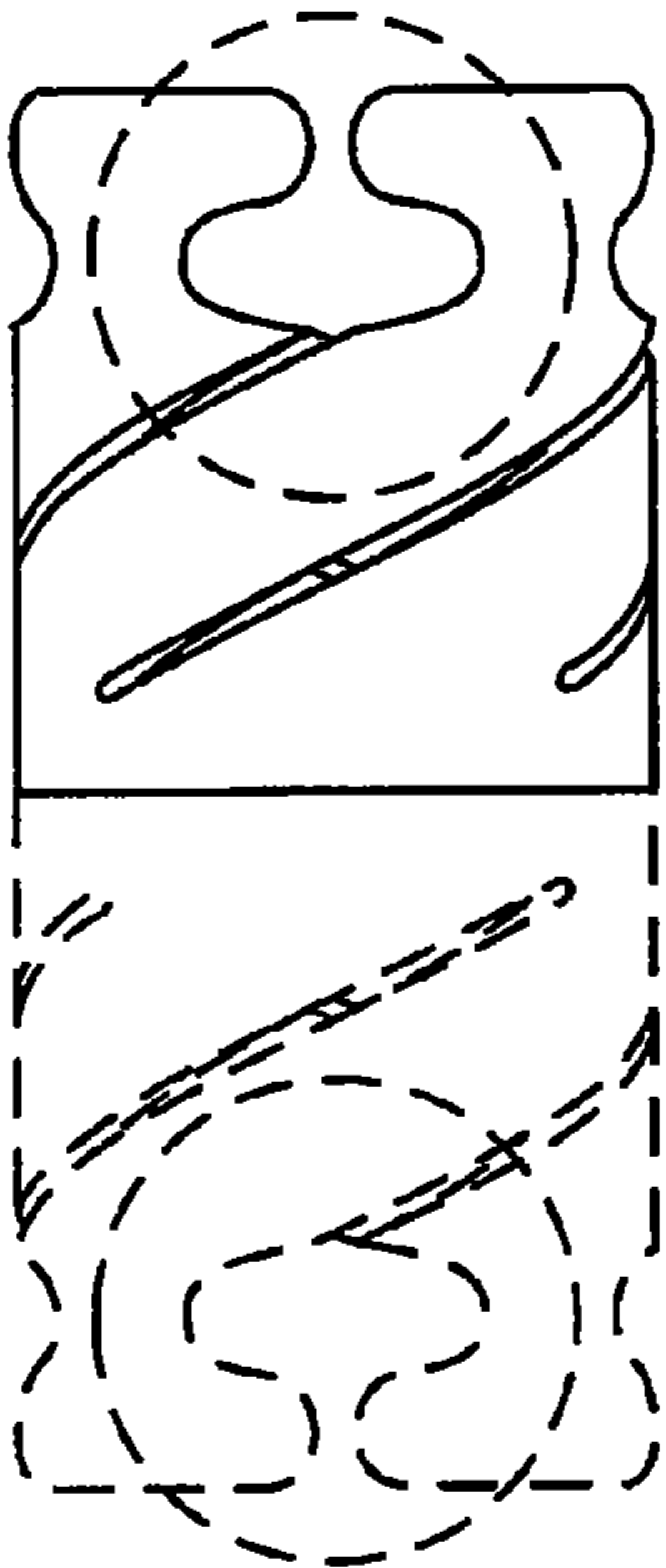


FIG. 7

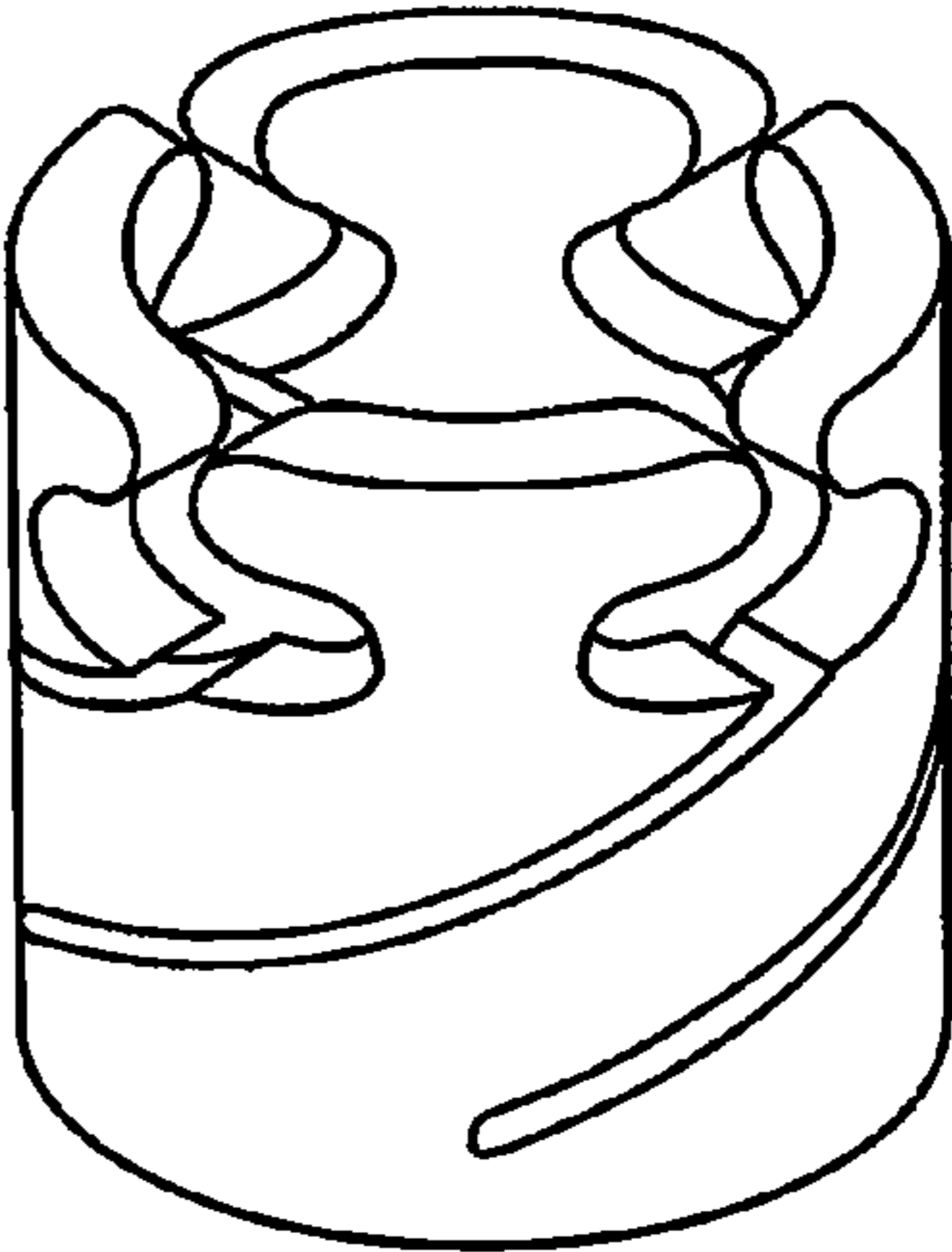


FIG. 1

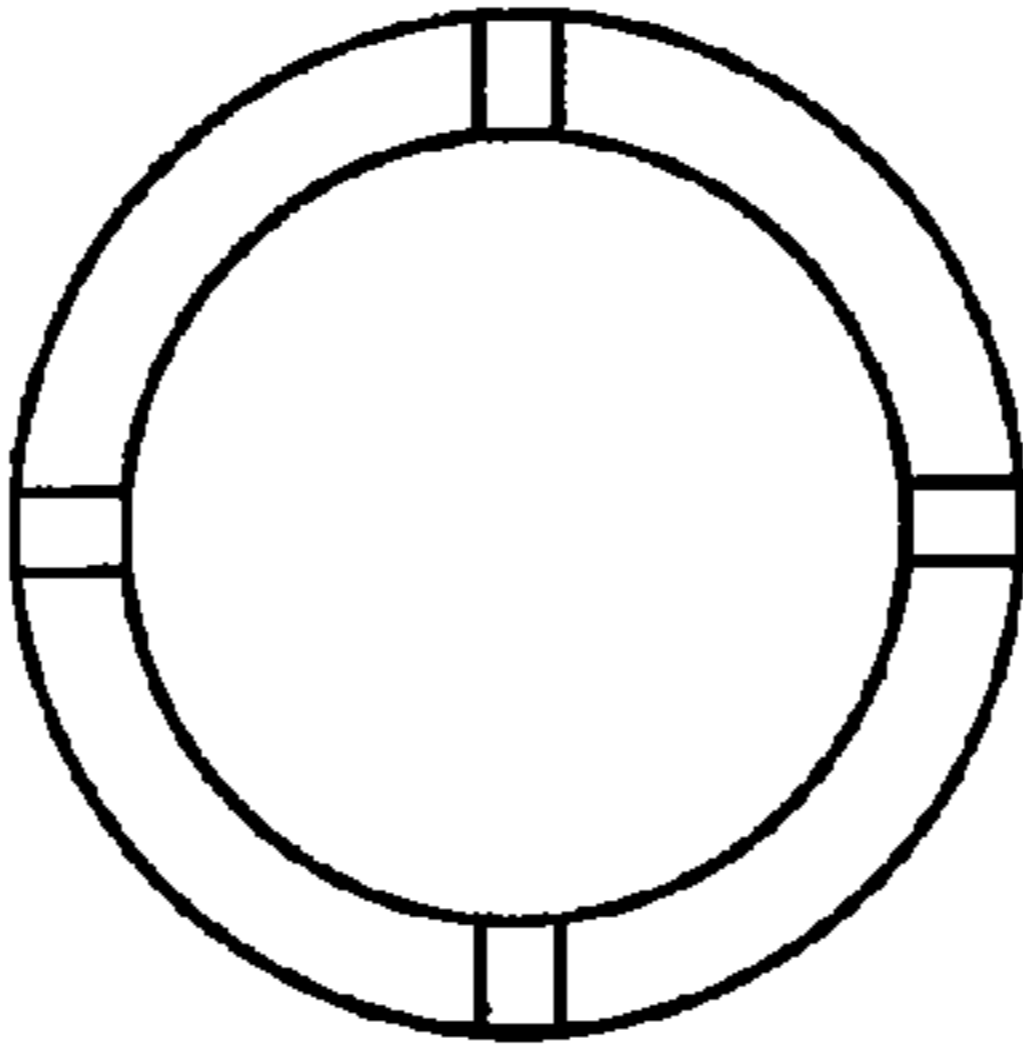


FIG. 6

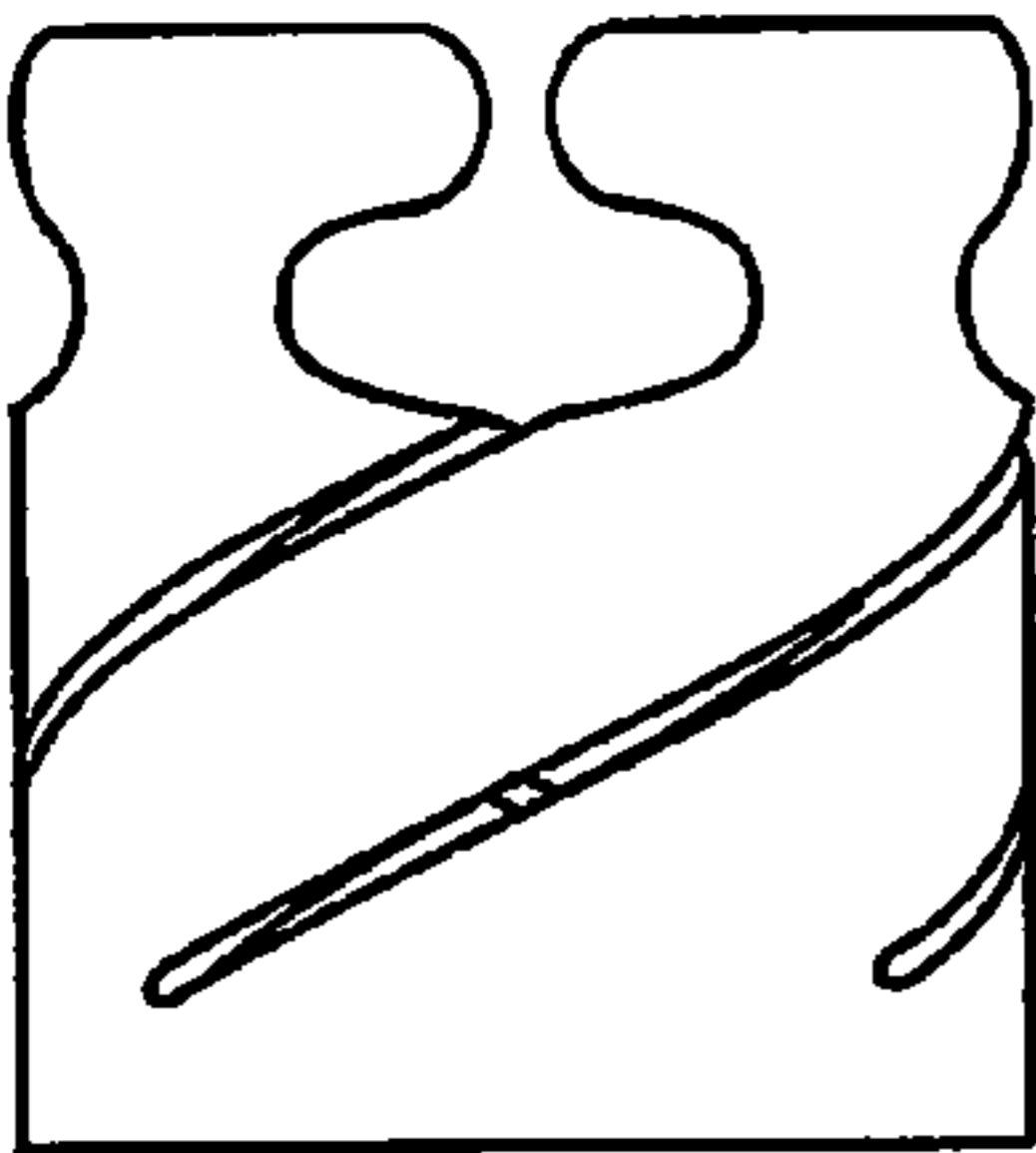


FIG. 3

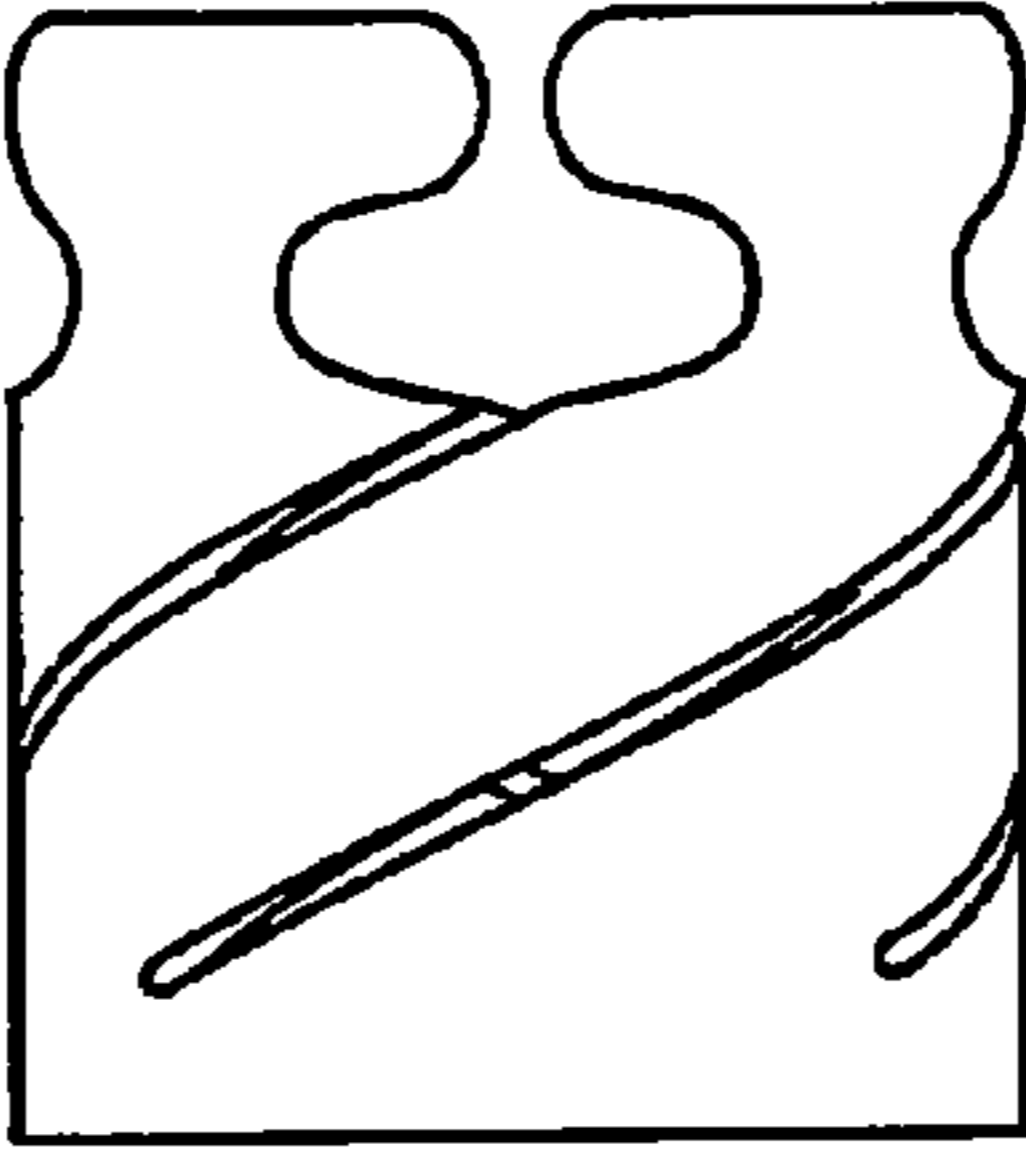


FIG. 2

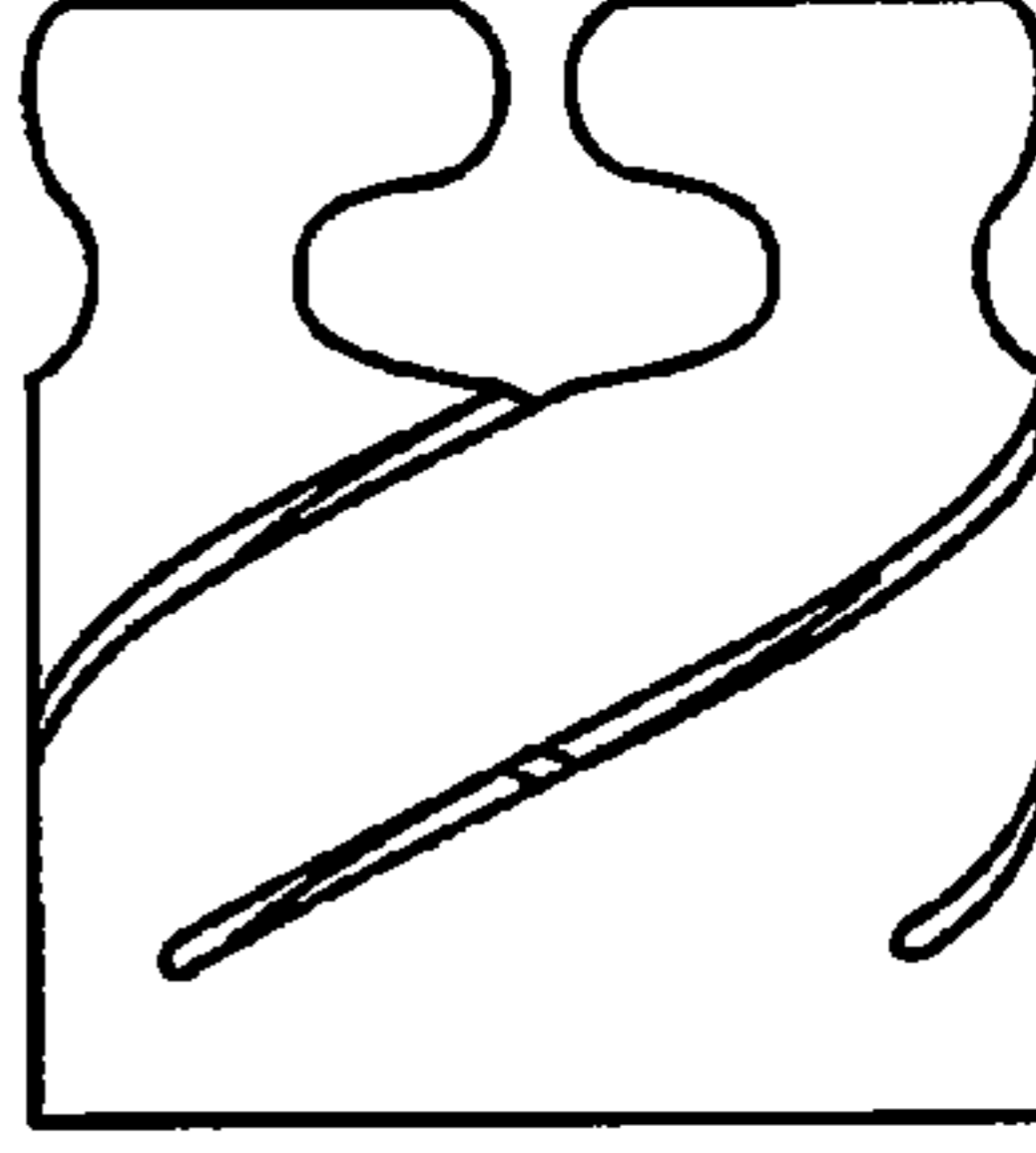


FIG. 4

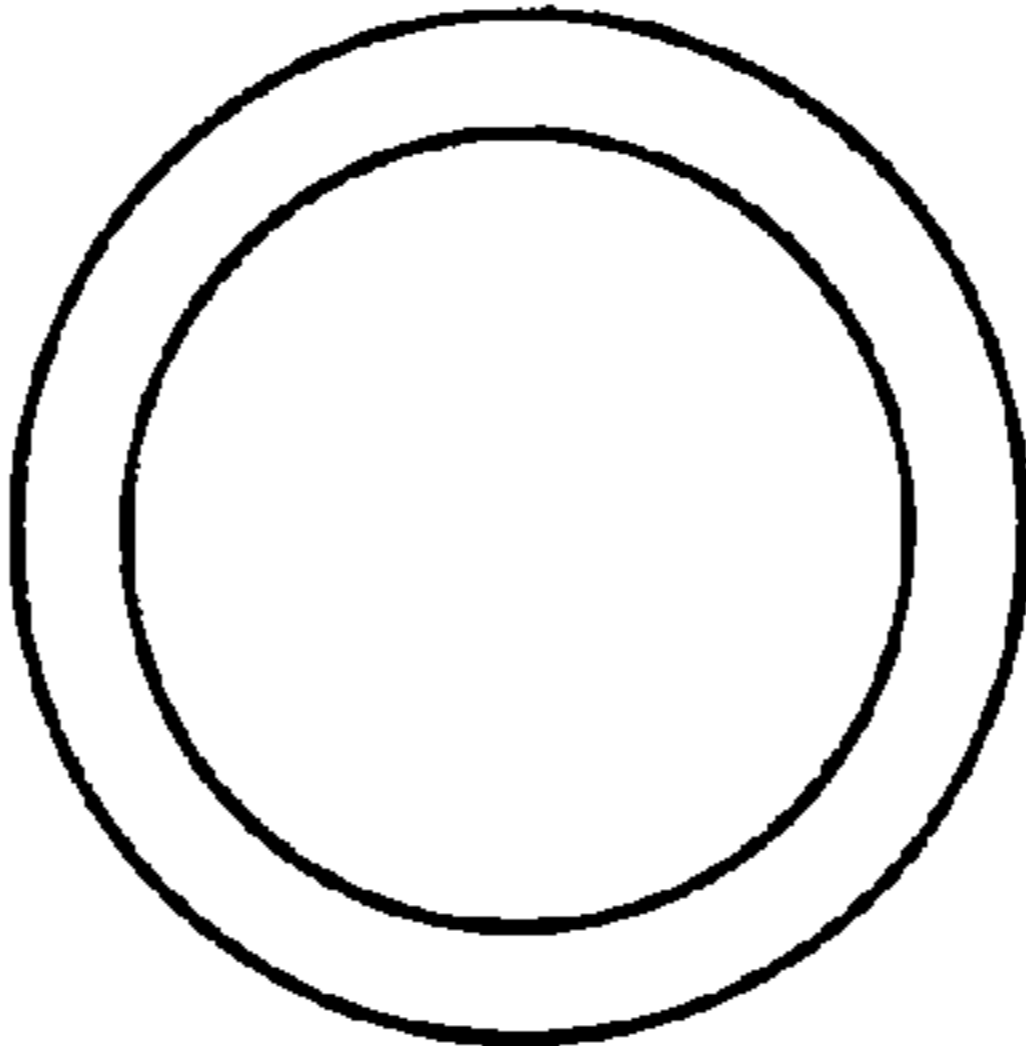


FIG. 5